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(54) Title: POLY-O-HYDROXYAMIDES COMPRISING NOVEL INDANE BIS-O-AMINOPHENOLS, PHOTSENSITIVE COMPOSITIONS, DIELECTRIC FILMS, AND BUFFER COATINGS CONTAINING THE SAME

(57) Abstract: This disclosure describes highly soluble novel poly-o-hydroxyamides containing indane bis-o-aminophenols, photosensitive compositions containing same, and methods and articles for use thereof.



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